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Linda D. Kennedy

Name of applicant, assignee or Registered Representative

Signatu<del>re -</del>

5/31/2001

Date of Signature

Our Case No. 7103/261 (P0704)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

in re	Application of:	)
ALLA	N M. RADMAN	) )
Seria	l No. 09/843,323	) Examiner TBD )
Filing Date: APRIL 25, 2001		, )    Group Art Unit No.  TBD )
For	SPHERICAL CAP-SHAPED POLISHING HEAD IN A CHEMICAL MECHANICAL POLISHING APPARATUS FOR SEMICONDUCTOR WAFERS	) ) )

## PRELIMINARY AMENDMENT

Commissioner for Patents Washington, D.C. 20231

Dear Sir:

Please enter the following preliminary amendment for the above-referenced patent application.